

## MLP2012S4R7MT0S1

Applications	Commercial Grade	
Feature	Multilayer Multilayer	
	Shield Magnetic Shield	
	Ferrite Core Ferrite Core	
Series	MLP Series / MLP2012 Type	
Status	Production	



Size		
Length(L)	2.00mm +/-0.20mm	
Width(W)	1.25mm +/-0.20mm	
Thickness(T)	0.85mm +/-0.15mm	
Recommended Land Pattern (A)	0.80mm Nom.	
Recommended Land Pattern (B)	1.00mm Nom.	
Recommended Land Pattern (C)	1.20mm Nom.	

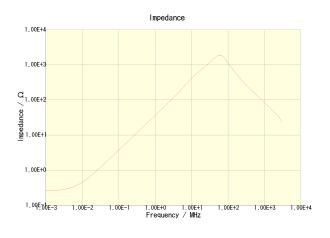
Electrical Characteristics			
Inductance	4.7uH +/-20% at 2MHz		
Rated Current (Temperature Rise) [Max.]	700mA (40degC Rise)		
DC Resistance [Nom.]	260mΩ		
DC Resistance [Max.]	338mΩ		

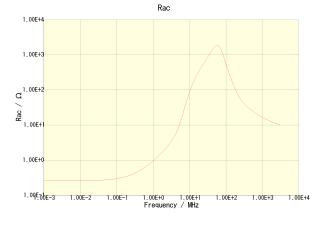
Other			
Operating Temp. Range (Including Self-Temp. Rise)	-40 to 125degC		
Soldering Method	Reflow, Iron Soldering		
AEC Q200	No		
Packing	Punched (Paper)Taping [180mm Reel]		
Package Quantity	4000Pcs Min.		
Weight	0.01g		

•This PDF document was created based on the data listed on the TDK Corporation website. •All specifications are subject to change without notice. **⊗TDK** Inductors(Coils)

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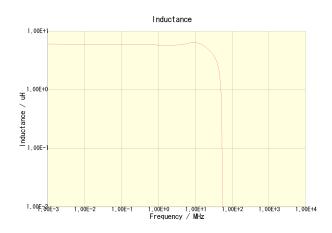
Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)

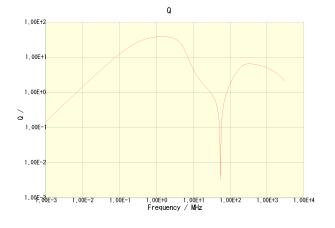




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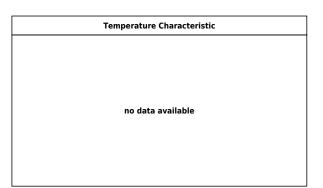
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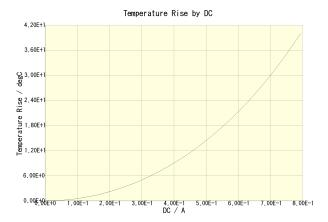
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MLP2012S4R7MT0S1(Amb. Temp. = 20degc)



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